

Information Disclosure Statement

U.S. Patent Application Serial No. 09/692,065

Your Ref. No.: A33631-067515.0107

Our Ref. No.: P00I5006/US

Issued Date by the Japanese Patent Office: November 19, 2003

Received Date from the Japanese Patent Office: December 2, 2003

Reference No.:

(1) JP Laid-Open No. 2000-513901